



Welcome to [E-XFL.COM](#)

### What is "[Embedded - Microcontrollers](#)"?

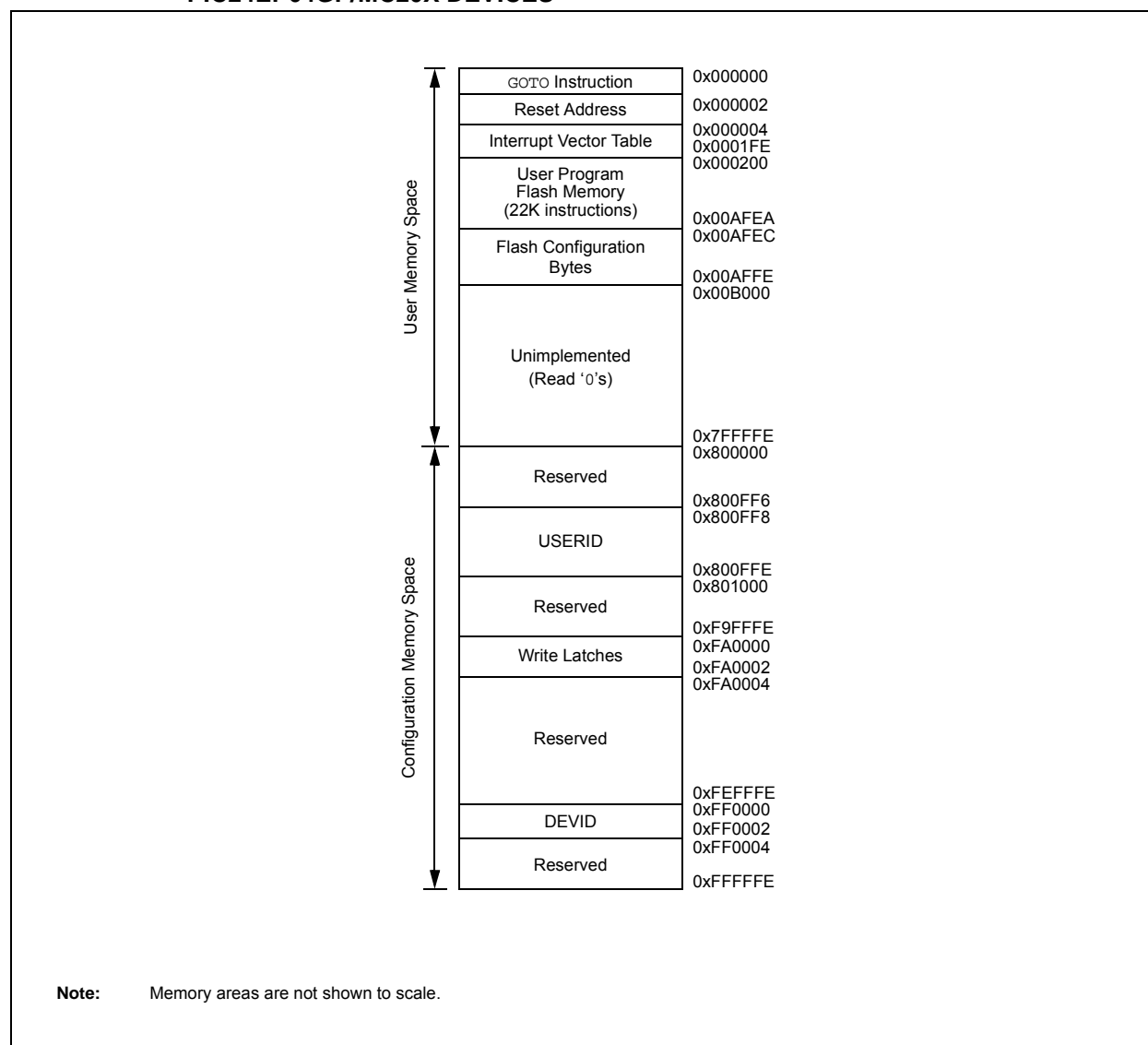
"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

### Applications of "[Embedded - Microcontrollers](#)"

#### Details

Product Status	Active
Core Processor	dsPIC
Core Size	16-Bit
Speed	70 MIPS
Connectivity	CANbus, I <sup>2</sup> C, IrDA, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, DMA, POR, PWM, WDT
Number of I/O	35
Program Memory Size	32KB (10.7K x 24)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	2K x 16
Voltage - Supply (Vcc/Vdd)	3V ~ 3.6V
Data Converters	A/D 9x10b/12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	44-TQFP
Supplier Device Package	44-TQFP (10x10)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/microchip-technology/dspic33ep32gp504t-i-pt">https://www.e-xfl.com/product-detail/microchip-technology/dspic33ep32gp504t-i-pt</a>

**FIGURE 4-2: PROGRAM MEMORY MAP FOR dsPIC33EP64GP50X, dsPIC33EP64MC20X/50X AND PIC24EP64GP/MC20X DEVICES**



**TABLE 4-39: PMD REGISTER MAP FOR dsPIC33EPXXXGP50X DEVICES ONLY**

File Name	Addr.	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
PMD1	0760	T5MD	T4MD	T3MD	T2MD	T1MD	—	—	—	I2C1MD	U2MD	U1MD	SPI2MD	SPI1MD	—	C1MD	AD1MD	0000
PMD2	0762	—	—	—	—	IC4MD	IC3MD	IC2MD	IC1MD	—	—	—	—	OC4MD	OC3MD	OC2MD	OC1MD	0000
PMD3	0764	—	—	—	—	—	CMPMD	—	—	CRCMD	—	—	—	—	—	I2C2MD	—	0000
PMD4	0766	—	—	—	—	—	—	—	—	—	—	—	—	REFOMD	CTMUMD	—	—	0000
PMD6	076A	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
PMD7	076C	—	—	—	—	—	—	—	—	—	—	—	DMA0MD	PTGMD	—	—	—	0000
													DMA1MD					
													DMA2MD					
													DMA3MD					

**Legend:** — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

**TABLE 4-40: PMD REGISTER MAP FOR dsPIC33EPXXXMC50X DEVICES ONLY**

File Name	Addr.	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
PMD1	0760	T5MD	T4MD	T3MD	T2MD	T1MD	QE1MD	PWMMD	—	I2C1MD	U2MD	U1MD	SPI2MD	SPI1MD	—	C1MD	AD1MD	0000
PMD2	0762	—	—	—	—	IC4MD	IC3MD	IC2MD	IC1MD	—	—	—	—	OC4MD	OC3MD	OC2MD	OC1MD	0000
PMD3	0764	—	—	—	—	—	CMPMD	—	—	CRCMD	—	—	—	—	—	I2C2MD	—	0000
PMD4	0766	—	—	—	—	—	—	—	—	—	—	—	—	REFOMD	CTMUMD	—	—	0000
PMD6	076A	—	—	—	—	—	PWM3MD	PWM2MD	PWM1MD	—	—	—	—	—	—	—	—	0000
PMD7	076C	—	—	—	—	—	—	—	—	—	—	—	DMA0MD	PTGMD	—	—	—	0000
													DMA1MD					
													DMA2MD					
													DMA3MD					

**Legend:** — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

#### 4.5.3 MOVE AND ACCUMULATOR INSTRUCTIONS

Move instructions, which apply to dsPIC33EPXXXGP50X, dsPIC33EPXXXMC20X/50X and PIC24EPXXXGP/MC20X devices, and the DSP accumulator class of instructions, which apply to the dsPIC33EPXXXMC20X/50X and dsPIC33EPXXXGP50X devices, provide a greater degree of addressing flexibility than other instructions. In addition to the addressing modes supported by most MCU instructions, move and accumulator instructions also support Register Indirect with Register Offset Addressing mode, also referred to as Register Indexed mode.

**Note:** For the MOV instructions, the addressing mode specified in the instruction can differ for the source and destination EA. However, the 4-bit Wb (Register Offset) field is shared by both source and destination (but typically only used by one).

In summary, the following addressing modes are supported by move and accumulator instructions:

- Register Direct
- Register Indirect
- Register Indirect Post-modified
- Register Indirect Pre-modified
- Register Indirect with Register Offset (Indexed)
- Register Indirect with Literal Offset
- 8-Bit Literal
- 16-Bit Literal

**Note:** Not all instructions support all the addressing modes given above. Individual instructions may support different subsets of these addressing modes.

#### 4.5.4 MAC INSTRUCTIONS (dsPIC33EPXXXMC20X/50X and dsPIC33EPXXXGP50X DEVICES ONLY)

The dual source operand DSP instructions (CLR, ED, EDAC, MAC, MPY, MPY.N, MOVSA and MSC), also referred to as MAC instructions, use a simplified set of addressing modes to allow the user application to effectively manipulate the Data Pointers through register indirect tables.

The Two-Source Operand Prefetch registers must be members of the set: {W8, W9, W10, W11}. For data reads, W8 and W9 are always directed to the X RAGU, and W10 and W11 are always directed to the Y AGU. The Effective Addresses generated (before and after modification) must therefore, be valid addresses within X Data Space for W8 and W9, and Y Data Space for W10 and W11.

**Note:** Register Indirect with Register Offset Addressing mode is available only for W9 (in X space) and W11 (in Y space).

In summary, the following addressing modes are supported by the MAC class of instructions:

- Register Indirect
- Register Indirect Post-Modified by 2
- Register Indirect Post-Modified by 4
- Register Indirect Post-Modified by 6
- Register Indirect with Register Offset (Indexed)

#### 4.5.5 OTHER INSTRUCTIONS

Besides the addressing modes outlined previously, some instructions use literal constants of various sizes. For example, BRA (branch) instructions use 16-bit signed literals to specify the branch destination directly, whereas the DISI instruction uses a 14-bit unsigned literal field. In some instructions, such as ULNK, the source of an operand or result is implied by the opcode itself. Certain operations, such as a NOP, do not have any operands.

**FIGURE 7-1: dsPIC33EPXXXGP50X, dsPIC33EPXXXMC20X/50X AND PIC24EPXXXGP/MC20X INTERRUPT VECTOR TABLE**

<div style="display: flex; align-items: center;"> <div style="writing-mode: vertical-rl; transform: rotate(180deg);">Decreasing Natural Order Priority</div> <div style="margin: 0 10px;"> <div style="height: 100px; border-left: 1px solid black; border-right: 1px solid black; position: relative;"> <div style="position: absolute; top: 0; left: -5px;">↑</div> <div style="position: absolute; bottom: 0; left: -5px;">↓</div> </div> <div style="writing-mode: vertical-rl; transform: rotate(180deg);">IVT</div> </div> </div>	Reset – GOTO Instruction	0x000000	<div style="display: flex; align-items: center;"> <div style="border-left: 1px solid black; border-right: 1px solid black; position: relative; height: 100px;"> <div style="position: absolute; top: 0; left: -5px;">↑</div> <div style="position: absolute; bottom: 0; left: -5px;">↓</div> </div> <div style="margin: 0 10px;"> <p>See Table 7-1 for Interrupt Vector Details</p> </div> </div>
	Reset – GOTO Address	0x000002	
	Oscillator Fail Trap Vector	0x000004	
	Address Error Trap Vector	0x000006	
	Generic Hard Trap Vector	0x000008	
	Stack Error Trap Vector	0x00000A	
	Math Error Trap Vector	0x00000C	
	DMAC Error Trap Vector	0x00000E	
	Generic Soft Trap Vector	0x000010	
	Reserved	0x000012	
	Interrupt Vector 0	0x000014	
	Interrupt Vector 1	0x000016	
	:	:	
	:	:	
	:	:	
	Interrupt Vector 52	0x00007C	
	Interrupt Vector 53	0x00007E	
	Interrupt Vector 54	0x000080	
	:	:	
	:	:	
	:	:	
	Interrupt Vector 116	0x0000FC	
	Interrupt Vector 117	0x0000FE	
	Interrupt Vector 118	0x000100	
	Interrupt Vector 119	0x000102	
	Interrupt Vector 120	0x000104	
	:	:	
	:	:	
	:	:	
	Interrupt Vector 244	0x0001FC	
	Interrupt Vector 245	0x0001FE	
	START OF CODE	0x000200	

**REGISTER 7-4: INTCON2: INTERRUPT CONTROL REGISTER 2**

R/W-1	R/W-0	R/W-0	U-0	U-0	U-0	U-0	U-0
GIE	DISI	SWTRAP	—	—	—	—	—
bit 15							bit 8

U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0
—	—	—	—	—	INT2EP	INT1EP	INT0EP
bit 7							bit 0

**Legend:**

R = Readable bit                      W = Writable bit                      U = Unimplemented bit, read as '0'  
 -n = Value at POR                      '1' = Bit is set                      '0' = Bit is cleared                      x = Bit is unknown

- bit 15            **GIE:** Global Interrupt Enable bit  
                   1 = Interrupts and associated IE bits are enabled  
                   0 = Interrupts are disabled, but traps are still enabled
- bit 14            **DISI:** DISI Instruction Status bit  
                   1 = DISI instruction is active  
                   0 = DISI instruction is not active
- bit 13            **SWTRAP:** Software Trap Status bit  
                   1 = Software trap is enabled  
                   0 = Software trap is disabled
- bit 12-3        **Unimplemented:** Read as '0'
- bit 2            **INT2EP:** External Interrupt 2 Edge Detect Polarity Select bit  
                   1 = Interrupt on negative edge  
                   0 = Interrupt on positive edge
- bit 1            **INT1EP:** External Interrupt 1 Edge Detect Polarity Select bit  
                   1 = Interrupt on negative edge  
                   0 = Interrupt on positive edge
- bit 0            **INT0EP:** External Interrupt 0 Edge Detect Polarity Select bit  
                   1 = Interrupt on negative edge  
                   0 = Interrupt on positive edge

- g) The TRISx registers control *only* the digital I/O output buffer. Any other dedicated or remappable active “output” will automatically override the TRIS setting. The TRISx register *does not* control the digital logic “input” buffer. Remappable digital “inputs” do not automatically override TRIS settings, which means that the TRISx bit must be set to input for pins with only remappable input function(s) assigned
- h) All analog pins are enabled by default after any Reset and the corresponding digital input buffer on the pin has been disabled. Only the Analog Pin Select registers control the digital input buffer, *not* the TRISx register. The user must disable the analog function on a pin using the Analog Pin Select registers in order to use any “digital input(s)” on a corresponding pin, no exceptions.

## 11.6 I/O Ports Resources

Many useful resources are provided on the main product page of the Microchip web site for the devices listed in this data sheet. This product page, which can be accessed using this link, contains the latest updates and additional information.

**Note:** In the event you are not able to access the product page using the link above, enter this URL in your browser:  
<http://www.microchip.com/wwwproducts/Devices.aspx?dDocName=en555464>

### 11.6.1 KEY RESOURCES

- “I/O Ports” (DS70598) in the “*dsPIC33/PIC24 Family Reference Manual*”
- Code Samples
- Application Notes
- Software Libraries
- Webinars
- All Related “*dsPIC33/PIC24 Family Reference Manual*” Sections
- Development Tools

**REGISTER 11-5: RPINR8: PERIPHERAL PIN SELECT INPUT REGISTER 8**

U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	IC4R<6:0>						
bit 15							bit 8

U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	IC3R<6:0>						
bit 7							bit 0

**Legend:**

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 15 **Unimplemented:** Read as '0'

bit 14-8 **IC4R<6:0>:** Assign Input Capture 4 (IC4) to the Corresponding RPn Pin bits  
(see Table 11-2 for input pin selection numbers)

1111001 = Input tied to RPI121

.

.

.

0000001 = Input tied to CMP1

0000000 = Input tied to Vss

bit 7 **Unimplemented:** Read as '0'

bit 6-0 **IC3R<6:0>:** Assign Input Capture 3 (IC3) to the Corresponding RPn Pin bits  
(see Table 11-2 for input pin selection numbers)

1111001 = Input tied to RPI121

.

.

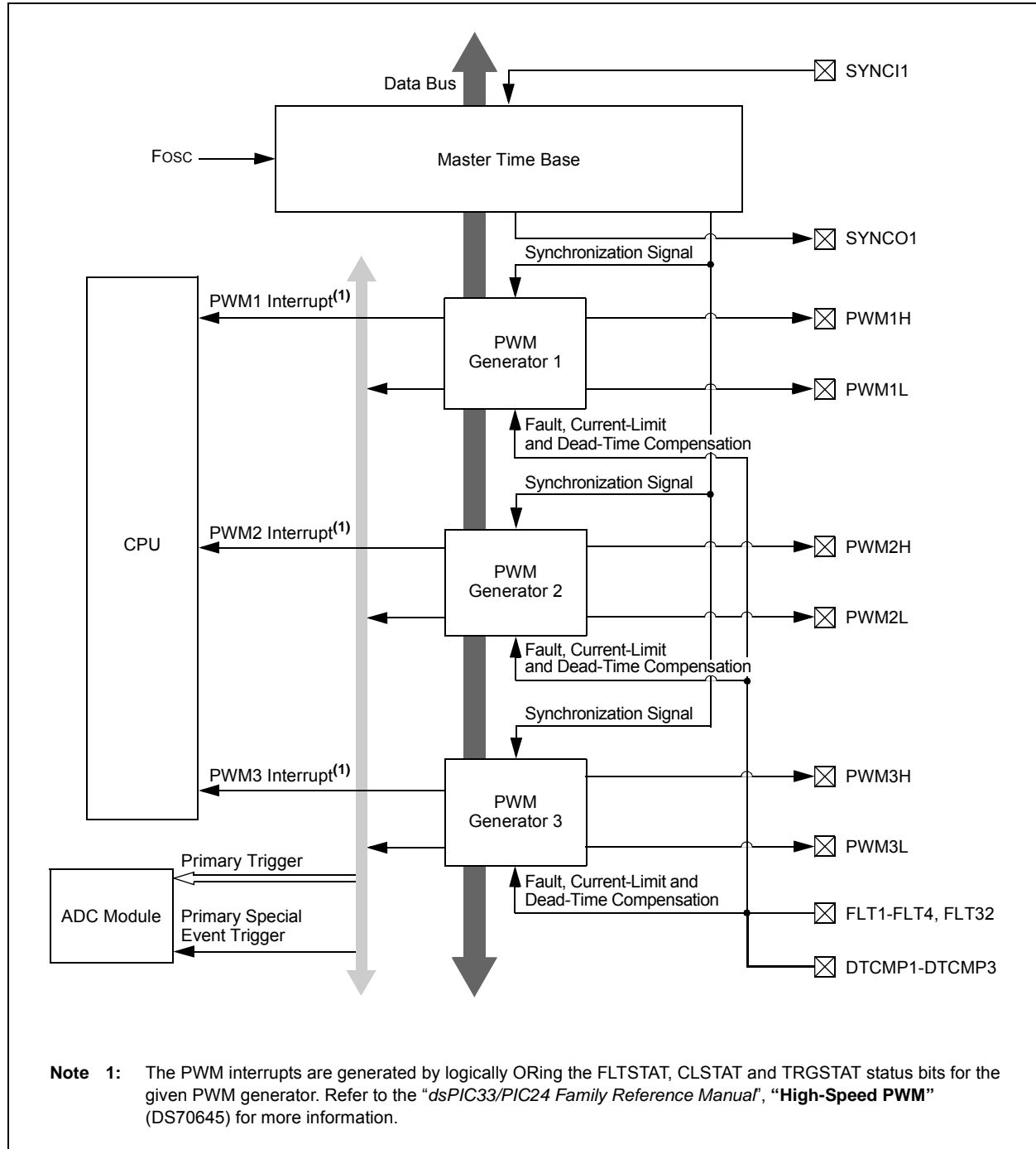
.

0000001 = Input tied to CMP1

0000000 = Input tied to Vss



FIGURE 16-1: HIGH-SPEED PWMx MODULE ARCHITECTURAL OVERVIEW



## 19.2 I<sup>2</sup>C Control Registers

**REGISTER 19-1: I2CxCON: I2Cx CONTROL REGISTER**

R/W-0	U-0	R/W-0	R/W-1, HC	R/W-0	R/W-0	R/W-0	R/W-0
I2CEN	—	I2CSIDL	SCLREL	IPMIEN <sup>(1)</sup>	A10M	DISSLW	SMEN
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0, HC	R/W-0, HC	R/W-0, HC	R/W-0, HC	R/W-0, HC
GCEN	STREN	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN
bit 7							bit 0

<b>Legend:</b>	HC = Hardware Clearable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

- bit 15      **I2CEN:** I2Cx Enable bit  
 1 = Enables the I2Cx module and configures the SDAx and SCLx pins as serial port pins  
 0 = Disables the I2Cx module; all I<sup>2</sup>C™ pins are controlled by port functions
- bit 14      **Unimplemented:** Read as '0'
- bit 13      **I2CSIDL:** I2Cx Stop in Idle Mode bit  
 1 = Discontinues module operation when device enters an Idle mode  
 0 = Continues module operation in Idle mode
- bit 12      **SCLREL:** SCLx Release Control bit (when operating as I<sup>2</sup>C slave)  
 1 = Releases SCLx clock  
 0 = Holds SCLx clock low (clock stretch)  
If STREN = 1:  
 Bit is R/W (i.e., software can write '0' to initiate stretch and write '1' to release clock). Hardware is clear at the beginning of every slave data byte transmission. Hardware is clear at the end of every slave address byte reception. Hardware is clear at the end of every slave data byte reception.  
If STREN = 0:  
 Bit is R/S (i.e., software can only write '1' to release clock). Hardware is clear at the beginning of every slave data byte transmission. Hardware is clear at the end of every slave address byte reception.
- bit 11      **IPMIEN:** Intelligent Peripheral Management Interface (IPMI) Enable bit<sup>(1)</sup>  
 1 = IPMI mode is enabled; all addresses are Acknowledged  
 0 = IPMI mode disabled
- bit 10      **A10M:** 10-Bit Slave Address bit  
 1 = I2CxADD is a 10-bit slave address  
 0 = I2CxADD is a 7-bit slave address
- bit 9      **DISSLW:** Disable Slew Rate Control bit  
 1 = Slew rate control is disabled  
 0 = Slew rate control is enabled
- bit 8      **SMEN:** SMBus Input Levels bit  
 1 = Enables I/O pin thresholds compliant with SMBus specification  
 0 = Disables SMBus input thresholds
- bit 7      **GCEN:** General Call Enable bit (when operating as I<sup>2</sup>C slave)  
 1 = Enables interrupt when a general call address is received in I2CxRSR (module is enabled for reception)  
 0 = General call address disabled

**Note 1:** When performing master operations, ensure that the IPMIEN bit is set to '0'.

**REGISTER 21-3: CxVEC: ECANx INTERRUPT CODE REGISTER**

U-0	U-0	U-0	R-0	R-0	R-0	R-0	R-0
—	—	—	FILHIT4	FILHIT3	FILHIT2	FILHIT1	FILHIT0
bit 15							bit 8

U-0	R-1	R-0	R-0	R-0	R-0	R-0	R-0
—	ICODE6	ICODE5	ICODE4	ICODE3	ICODE2	ICODE1	ICODE0
bit 7							bit 0

**Legend:**

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 15-13 **Unimplemented:** Read as '0'

bit 12-8 **FILHIT<4:0>:** Filter Hit Number bits

10000-11111 = Reserved

01111 = Filter 15

•  
•  
•

00001 = Filter 1

00000 = Filter 0

bit 7 **Unimplemented:** Read as '0'

bit 6-0 **ICODE<6:0>:** Interrupt Flag Code bits

1000101-1111111 = Reserved

1000100 = FIFO almost full interrupt

1000011 = Receiver overflow interrupt

1000010 = Wake-up interrupt

1000001 = Error interrupt

1000000 = No interrupt

•  
•  
•

0010000-0111111 = Reserved

0001111 = RB15 buffer interrupt

•  
•  
•

0001001 = RB9 buffer interrupt

0001000 = RB8 buffer interrupt

0000111 = TRB7 buffer interrupt

0000110 = TRB6 buffer interrupt

0000101 = TRB5 buffer interrupt

0000100 = TRB4 buffer interrupt

0000011 = TRB3 buffer interrupt

0000010 = TRB2 buffer interrupt

0000001 = TRB1 buffer interrupt

0000000 = TRB0 buffer interrupt

## 22.0 CHARGE TIME MEASUREMENT UNIT (CTMU)

**Note 1:** This data sheet summarizes the features of the dsPIC33EPXXXGP50X, dsPIC33EPXXXMC20X/50X and PIC24EPXXXGP/MC20X family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to “**Charge Time Measurement Unit (CTMU)**” (DS70661) in the “*dsPIC33/PIC24 Family Reference Manual*”, which is available on the Microchip web site ([www.microchip.com](http://www.microchip.com)).

**2:** Some registers and associated bits described in this section may not be available on all devices. Refer to **Section 4.0 “Memory Organization”** in this data sheet for device-specific register and bit information.

The Charge Time Measurement Unit is a flexible analog module that provides accurate differential time measurement between pulse sources, as well as asynchronous pulse generation. Its key features include:

- Four Edge Input Trigger Sources
- Polarity Control for Each Edge Source
- Control of Edge Sequence
- Control of Response to Edges
- Precise Time Measurement Resolution of 1 ns
- Accurate Current Source Suitable for Capacitive Measurement
- On-Chip Temperature Measurement using a Built-in Diode

Together with other on-chip analog modules, the CTMU can be used to precisely measure time, measure capacitance, measure relative changes in capacitance or generate output pulses that are independent of the system clock.

The CTMU module is ideal for interfacing with capacitive-based sensors. The CTMU is controlled through three registers: CTMUCON1, CTMUCON2 and CTMUICON. CTMUCON1 and CTMUCON2 enable the module and control edge source selection, edge source polarity selection and edge sequencing. The CTMUICON register controls the selection and trim of the current source.

**REGISTER 23-1: AD1CON1: ADC1 CONTROL REGISTER 1 (CONTINUED)**

bit 7-5	<p><b>SSRC&lt;2:0&gt;:</b> Sample Trigger Source Select bits</p> <p><u>If SSRCG = 1:</u></p> <p>111 = Reserved</p> <p>110 = PTGO15 primary trigger compare ends sampling and starts conversion<sup>(1)</sup></p> <p>101 = PTGO14 primary trigger compare ends sampling and starts conversion<sup>(1)</sup></p> <p>100 = PTGO13 primary trigger compare ends sampling and starts conversion<sup>(1)</sup></p> <p>011 = PTGO12 primary trigger compare ends sampling and starts conversion<sup>(1)</sup></p> <p>010 = PWM Generator 3 primary trigger compare ends sampling and starts conversion<sup>(2)</sup></p> <p>001 = PWM Generator 2 primary trigger compare ends sampling and starts conversion<sup>(2)</sup></p> <p>000 = PWM Generator 1 primary trigger compare ends sampling and starts conversion<sup>(2)</sup></p> <p><u>If SSRCG = 0:</u></p> <p>111 = Internal counter ends sampling and starts conversion (auto-convert)</p> <p>110 = CTMU ends sampling and starts conversion</p> <p>101 = Reserved</p> <p>100 = Timer5 compare ends sampling and starts conversion</p> <p>011 = PWM primary Special Event Trigger ends sampling and starts conversion<sup>(2)</sup></p> <p>010 = Timer3 compare ends sampling and starts conversion</p> <p>001 = Active transition on the INT0 pin ends sampling and starts conversion</p> <p>000 = Clearing the Sample bit (SAMP) ends sampling and starts conversion (Manual mode)</p>
bit 4	<p><b>SSRCG:</b> Sample Trigger Source Group bit</p> <p>See SSRC&lt;2:0&gt; for details.</p>
bit 3	<p><b>SIMSAM:</b> Simultaneous Sample Select bit (only applicable when CHPS&lt;1:0&gt; = 01 or 1x)</p> <p><u>In 12-bit mode (AD21B = 1), SIMSAM is Unimplemented and is Read as '0':</u></p> <p>1 = Samples CH0, CH1, CH2, CH3 simultaneously (when CHPS&lt;1:0&gt; = 1x); or samples CH0 and CH1 simultaneously (when CHPS&lt;1:0&gt; = 01)</p> <p>0 = Samples multiple channels individually in sequence</p>
bit 2	<p><b>ASAM:</b> ADC1 Sample Auto-Start bit</p> <p>1 = Sampling begins immediately after the last conversion; SAMP bit is auto-set</p> <p>0 = Sampling begins when the SAMP bit is set</p>
bit 1	<p><b>SAMP:</b> ADC1 Sample Enable bit</p> <p>1 = ADC Sample-and-Hold amplifiers are sampling</p> <p>0 = ADC Sample-and-Hold amplifiers are holding</p> <p>If ASAM = 0, software can write '1' to begin sampling. Automatically set by hardware if ASAM = 1. If SSRC&lt;2:0&gt; = 000, software can write '0' to end sampling and start conversion. If SSRC&lt;2:0&gt; ≠ 000, automatically cleared by hardware to end sampling and start conversion.</p>
bit 0	<p><b>DONE:</b> ADC1 Conversion Status bit<sup>(3)</sup></p> <p>1 = ADC conversion cycle has completed</p> <p>0 = ADC conversion has not started or is in progress</p> <p>Automatically set by hardware when the ADC conversion is complete. Software can write '0' to clear the DONE status bit (software is not allowed to write '1'). Clearing this bit does NOT affect any operation in progress. Automatically cleared by hardware at the start of a new conversion.</p>

- Note 1:** See Section 24.0 “Peripheral Trigger Generator (PTG) Module” for information on this selection.
- 2:** This setting is available in dsPIC33EPXXXMC20X/50X and PIC24EPXXXMC20X devices only.
- 3:** Do not clear the DONE bit in software if Auto-Sample is enabled (ASAM = 1).

**TABLE 27-2: CONFIGURATION BITS DESCRIPTION (CONTINUED)**

Bit Field	Description
WDTPRE	Watchdog Timer Prescaler bit 1 = 1:128 0 = 1:32
WDTPOST<3:0>	Watchdog Timer Postscaler bits 1111 = 1:32,768 1110 = 1:16,384 • • • 0001 = 1:2 0000 = 1:1
WDTWIN<1:0>	Watchdog Window Select bits 11 = WDT window is 25% of WDT period 10 = WDT window is 37.5% of WDT period 01 = WDT window is 50% of WDT period 00 = WDT window is 75% of WDT period
ALTI2C1	Alternate I2C1 pin 1 = I2C1 is mapped to the SDA1/SCL1 pins 0 = I2C1 is mapped to the ASDA1/ASCL1 pins
ALTI2C2	Alternate I2C2 pin 1 = I2C2 is mapped to the SDA2/SCL2 pins 0 = I2C2 is mapped to the ASDA2/ASCL2 pins
JTAGEN <sup>(2)</sup>	JTAG Enable bit 1 = JTAG is enabled 0 = JTAG is disabled
ICS<1:0>	ICD Communication Channel Select bits 11 = Communicate on PGEC1 and PGED1 10 = Communicate on PGEC2 and PGED2 01 = Communicate on PGEC3 and PGED3 00 = Reserved, do not use

**Note 1:** This bit is only available on dsPIC33EPXXXMC20X/50X and PIC24EPXXXMC20X devices.

**2:** When JTAGEN = 1, an internal pull-up resistor is enabled on the TMS pin. Erased devices default to JTAGEN = 1. Applications requiring I/O pins in a high-impedance state (tri-state) in Reset should use pins other than TMS for this purpose.

FIGURE 30-5: TIMER1-TIMER5 EXTERNAL CLOCK TIMING CHARACTERISTICS

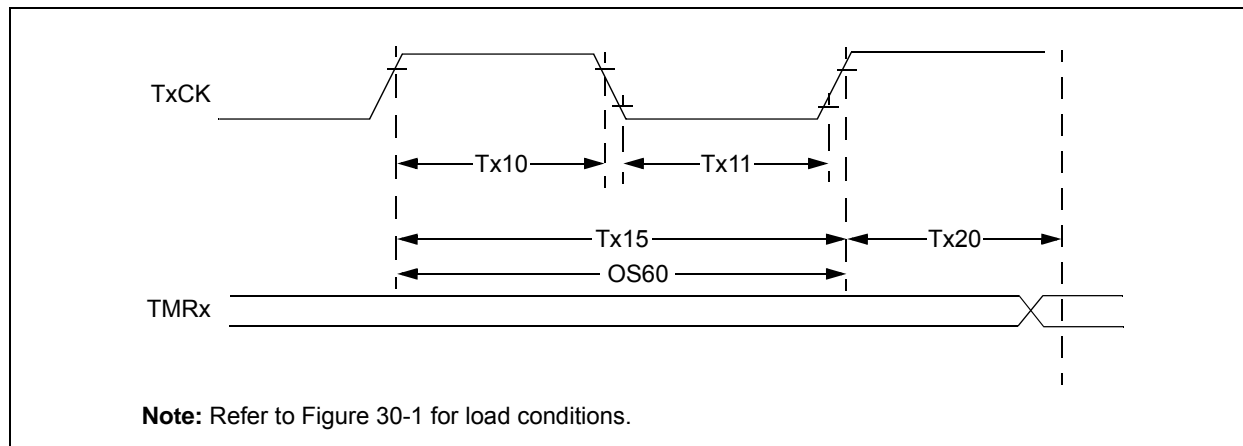


TABLE 30-23: TIMER1 EXTERNAL CLOCK TIMING REQUIREMENTS<sup>(1)</sup>

AC CHARACTERISTICS				Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended				
Param No.	Symbol	Characteristic <sup>(2)</sup>		Min.	Typ.	Max.	Units	Conditions
TA10	TtxH	T1CK High Time	Synchronous mode	Greater of: 20 or (Tcy + 20)/N	—	—	ns	Must also meet Parameter TA15, N = prescaler value (1, 8, 64, 256)
			Asynchronous	35	—	—	ns	
TA11	TtxL	T1CK Low Time	Synchronous mode	Greater of: 20 or (Tcy + 20)/N	—	—	ns	Must also meet Parameter TA15, N = prescaler value (1, 8, 64, 256)
			Asynchronous	10	—	—	ns	
TA15	TtxP	T1CK Input Period	Synchronous mode	Greater of: 40 or (2 Tcy + 40)/N	—	—	ns	N = prescale value (1, 8, 64, 256)
OS60	Ft1	T1CK Oscillator Input Frequency Range (oscillator enabled by setting bit, TCS (T1CON<1>))		DC	—	50	kHz	
TA20	TCKEXTMRL	Delay from External T1CK Clock Edge to Timer Increment		0.75 Tcy + 40	—	1.75 Tcy + 40	ns	

**Note 1:** Timer1 is a Type A.

**2:** These parameters are characterized, but are not tested in manufacturing.

**FIGURE 30-27: SPI1 SLAVE MODE (FULL-DUPLEX, CKE = 1, CKP = 1, SMP = 0)**  
**TIMING CHARACTERISTICS**

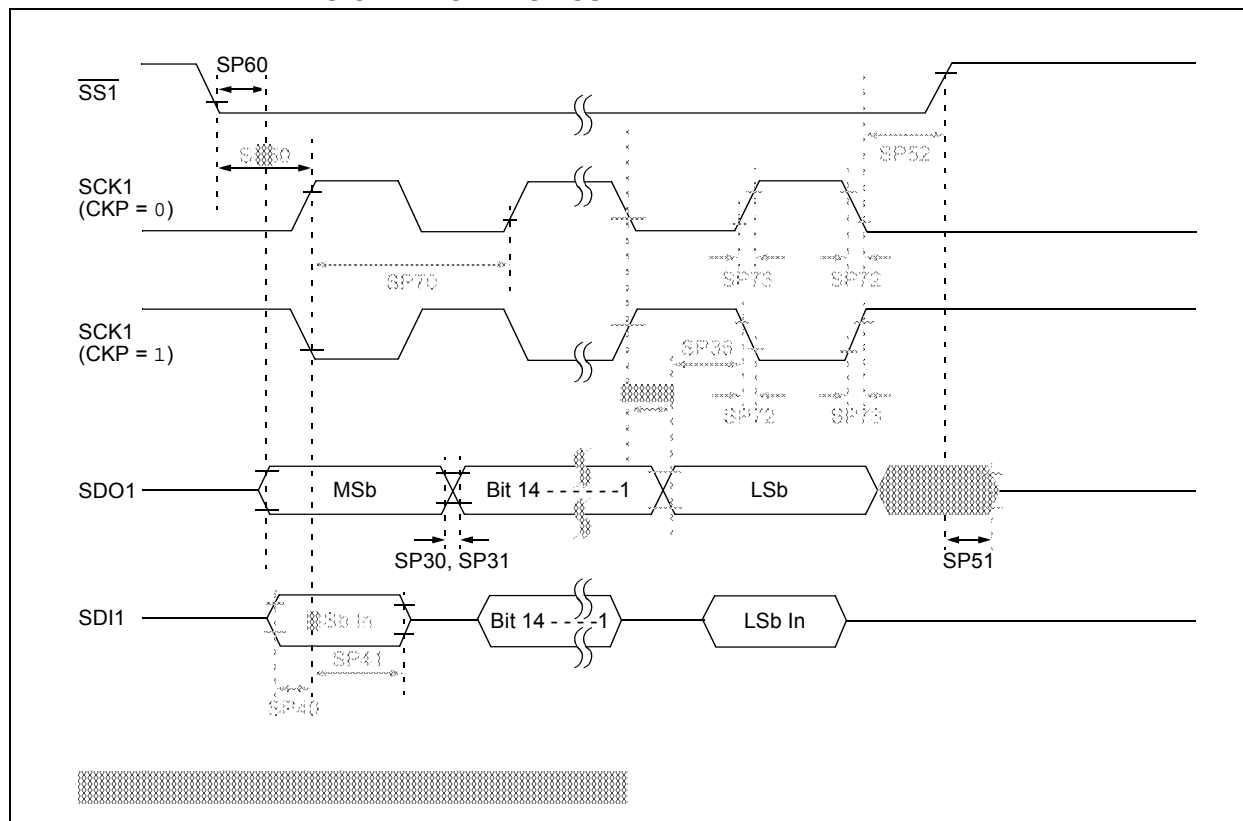




TABLE 30-53: OP AMP/COMPARATOR SPECIFICATIONS (CONTINUED)

DC CHARACTERISTICS			Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) <sup>(1)</sup> Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended				
Param No.	Symbol	Characteristic	Min.	Typ. <sup>(2)</sup>	Max.	Units	Conditions
<b>Op Amp DC Characteristics</b>							
CM40	VCMR	Common-Mode Input Voltage Range	AVSS	—	AVDD	V	
CM41	CMRR	Common-Mode Rejection Ratio <sup>(3)</sup>	—	40	—	db	VCM = AVDD/2
CM42	VOFFSET	Op Amp Offset Voltage <sup>(3)</sup>	—	±5	—	mV	
CM43	VGAIN	Open-Loop Voltage Gain <sup>(3)</sup>	—	90	—	db	
CM44	IOS	Input Offset Current	—	—	—	—	See pad leakage currents in Table 30-11
CM45	IB	Input Bias Current	—	—	—	—	See pad leakage currents in Table 30-11
CM46	IOUT	Output Current	—	—	420	μA	With minimum value of RFEEDBACK (CM48)
CM48	RFEEDBACK	Feedback Resistance Value	8	—	—	kΩ	
CM49a	VOADC	Output Voltage Measured at OAx Using ADC <sup>(3,4)</sup>	AVSS + 0.077 AVSS + 0.037 AVSS + 0.018	— — —	AVDD – 0.077 AVDD – 0.037 AVDD – 0.018	V V V	IOUT = 420 μA IOUT = 200 μA IOUT = 100 μA
CM49b	VOOUT	Output Voltage Measured at OAxOUT Pin <sup>(3,4,5)</sup>	AVSS + 0.210 AVSS + 0.100 AVSS + 0.050	— — —	AVDD – 0.210 AVDD – 0.100 AVDD – 0.050	V V V	IOUT = 420 μA IOUT = 200 μA IOUT = 100 μA
CM51	RINT1 <sup>(6)</sup>	Internal Resistance 1 (Configuration A and B) <sup>(3,4,5)</sup>	198	264	317	Ω	Min = -40°C Typ = +25°C Max = +125°C

**Note 1:** Device is functional at VBORMIN < VDD < VDDMIN, but will have degraded performance. Device functionality is tested, but not characterized. Analog modules (ADC, op amp/comparator and comparator voltage reference) may have degraded performance. Refer to Parameter BO10 in Table 30-13 for the minimum and maximum BOR values.

**2:** Data in “Typ” column is at 3.3V, +25°C unless otherwise stated.

**3:** Parameter is characterized but not tested in manufacturing.

**4:** See Figure 25-6 for configuration information.

**5:** See Figure 25-7 for configuration information.

**6:** Resistances can vary by ±10% between op amps.

TABLE 30-54: OP AMP/COMPARATOR VOLTAGE REFERENCE SETTling TIME SPECIFICATIONS

AC CHARACTERISTICS			Standard Operating Conditions (see Note 2): 3.0V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended				
Param.	Symbol	Characteristic	Min.	Typ.	Max.	Units	Conditions
VR310	TSET	Settling Time	—	1	10	μs	(Note 1)

**Note 1:** Settling time is measured while CVRR = 1 and CVR<3:0> bits transition from '0000' to '1111'.

**2:** Device is functional at VBORMIN < VDD < VDDMIN, but will have degraded performance. Device functionality is tested, but not characterized. Analog modules (ADC, op amp/comparator and comparator voltage reference) may have degraded performance. Refer to Parameter BO10 in Table 30-13 for the minimum and maximum BOR values.

TABLE 30-55: OP AMP/COMPARATOR VOLTAGE REFERENCE SPECIFICATIONS

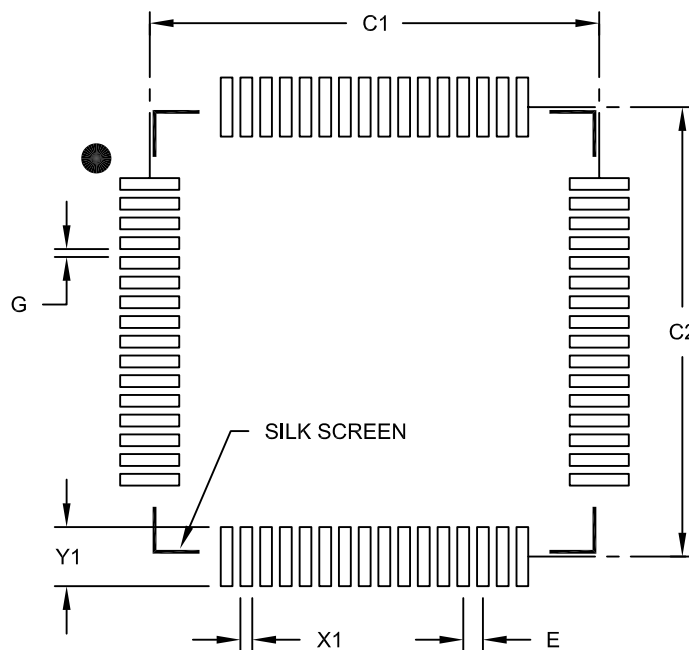
DC CHARACTERISTICS			Standard Operating Conditions (see Note 1): 3.0V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended				
Param No.	Symbol	Characteristics	Min.	Typ.	Max.	Units	Conditions
VRD310	CVRES	Resolution	CVRSRC/24	—	CVRSRC/32	LSb	
VRD311	CVRAA	Absolute Accuracy <sup>(2)</sup>	—	±25	—	mV	CVRSRC = 3.3V
VRD313	CVRSRC	Input Reference Voltage	0	—	AVDD + 0.3	V	
VRD314	CVRROUT	Buffer Output Resistance <sup>(2)</sup>	—	1.5k	—	Ω	

**Note 1:** Device is functional at VBORMIN < VDD < VDDMIN, but will have degraded performance. Device functionality is tested, but not characterized. Analog modules (ADC, op amp/comparator and comparator voltage reference) may have degraded performance. Refer to Parameter BO10 in Table 30-13 for the minimum and maximum BOR values.

**2:** Parameter is characterized but not tested in manufacturing.

**64-Lead Plastic Thin Quad Flatpack (PT) 10x10x1 mm Body, 2.00 mm Footprint [TQFP]**

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



**RECOMMENDED LAND PATTERN**

Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Contact Pitch	E	0.50 BSC		
Contact Pad Spacing	C1		11.40	
Contact Pad Spacing	C2		11.40	
Contact Pad Width (X64)	X1			0.30
Contact Pad Length (X64)	Y1			1.50
Distance Between Pads	G	0.20		

**Notes:**

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2085B

## Revision F (November 2012)

Removed “Preliminary” from data sheet footer.

## Revision G (March 2013)

This revision includes the following global changes:

- changes “ $\overline{\text{FLT}}\text{x}$ ” pin function to “FLT $\text{x}$ ” on all occurrences
- adds **Section 31.0 “High-Temperature Electrical Characteristics”** for high-temperature (+150°C) data

This revision also includes minor typographical and formatting changes throughout the text.

Other major changes are referenced by their respective section in Table A-5.

**TABLE A-5: MAJOR SECTION UPDATES**

Section Name	Update Description
<b>Cover Section</b>	<ul style="list-style-type: none"> <li>• Changes internal oscillator specification to 1.0%</li> <li>• Changes I/O sink/source values to 12 mA or 6 mA</li> <li>• Corrects 44-pin VTLA pin diagram (pin 32 now shows as 5V tolerant)</li> </ul>
<b>Section 4.0 “Memory Organization”</b>	<ul style="list-style-type: none"> <li>• Deletes references to Configuration Shadow registers</li> <li>• Corrects the spelling of the JTAGIP and PTGWDTIP bits throughout</li> <li>• Corrects the Reset value of all IOCON registers as C000h</li> <li>• Adds footnote to Table 4-42 to indicate the absence of Comparator 3 in 28-pin devices</li> </ul>
<b>Section 6.0 “Resets”</b>	<ul style="list-style-type: none"> <li>• Removes references to cold and warm Resets, and clarifies the initial configuration of the device clock source on all Resets</li> </ul>
<b>Section 7.0 “Interrupt Controller”</b>	<ul style="list-style-type: none"> <li>• Corrects the definition of GIE as “Global Interrupt Enable” (not “General”)</li> </ul>
<b>Section 9.0 “Oscillator Configuration”</b>	<ul style="list-style-type: none"> <li>• Clarifies the behavior of the CF bit when cleared in software</li> <li>• Removes POR behavior footnotes from all control registers</li> <li>• Corrects the tuning range of the TUN&lt;5:0&gt; bits in Register 9-4 to an overall range <math>\pm 1.5\%</math></li> </ul>
<b>Section 13.0 “Timer2/3 and Timer4/5”</b>	<ul style="list-style-type: none"> <li>• Clarifies the presence of the ADC Trigger in 16-bit Timer3 and Timer5, as well as the 32-bit timers</li> </ul>
<b>Section 15.0 “Output Compare”</b>	<ul style="list-style-type: none"> <li>• Corrects the first trigger source for SYNCSEL&lt;4:0&gt; (OCxCON2&lt;4:0&gt;) as OCxRS match</li> </ul>
<b>Section 16.0 “High-Speed PWM Module”</b>	<ul style="list-style-type: none"> <li>• Clarifies the source of the PWM interrupts in Figure 16-1</li> <li>• Corrects the Reset states of IOCONx&lt;15:14&gt; in Register 16-13 as ‘11’</li> </ul>
<b>Section 17.0 “Quadrature Encoder Interface (QEI) Module”</b>	<ul style="list-style-type: none"> <li>• Clarifies the operation of the IMV&lt;1:0&gt; bits (QEICON&lt;9:8&gt;) with updated text and additional notes</li> <li>• Corrects the first prescaler value for QFVDIV&lt;2:0&gt; (QE1IOC&lt;13:11&gt;), now 1:128</li> </ul>
<b>Section 23.0 “10-Bit/12-Bit Analog-to-Digital Converter (ADC)”</b>	<ul style="list-style-type: none"> <li>• Adds note to Figure 23-1 that Op Amp 3 is not available in 28-pin devices</li> <li>• Changes “sample clock” to “sample trigger” in AD1CON1 (Register 23-1)</li> <li>• Clarifies footnotes on op amp usage in Registers 23-5 and 23-6</li> </ul>
<b>Section 25.0 “Op Amp/Comparator Module”</b>	<ul style="list-style-type: none"> <li>• Adds Note text to indicate that Comparator 3 is unavailable in 28-pin devices</li> <li>• Splits Figure 25-1 into two figures for clearer presentation (Figure 25-1 for Op amp/Comparators 1 through 3, Figure 25-2 for Comparator 4). Subsequent figures are renumbered accordingly.</li> <li>• Corrects reference description in xxxxx (now (AVDD+AVSS)/2)</li> <li>• Changes CMSTAT&lt;15&gt; in Register 25-1 to “PSIDL”</li> </ul>
<b>Section 27.0 “Special Features”</b>	<ul style="list-style-type: none"> <li>• Corrects the addresses of all Configuration bytes for 512 Kbyte devices</li> </ul>

## INDEX

## A

Absolute Maximum Ratings .....	401
AC Characteristics .....	413, 471
10-Bit ADC Conversion Requirements .....	465
12-Bit ADC Conversion Requirements .....	463
ADC Module .....	459
ADC Module (10-Bit Mode) .....	461, 473
ADC Module (12-Bit Mode) .....	460, 473
Capacitive Loading Requirements on Output Pins .....	413
DMA Module Requirements .....	465
ECANx I/O Requirements .....	454
External Clock .....	414
High-Speed PWMx Requirements .....	422
I/O Timing Requirements .....	416
I2Cx Bus Data Requirements (Master Mode) .....	451
I2Cx Bus Data Requirements (Slave Mode) .....	453
Input Capture x Requirements .....	420
Internal FRC Accuracy .....	415
Internal LPRC Accuracy .....	415
Internal RC Accuracy .....	472
Load Conditions .....	413, 471
OCx/PWMx Mode Requirements .....	421
Op Amp/Comparator Voltage Reference Settling Time Specifications .....	457
Output Compare x Requirements .....	421
PLL Clock .....	415, 471
QE1 External Clock Requirements .....	423
QE1 Index Pulse Requirements .....	425
Quadrature Decoder Requirements .....	424
Reset, Watchdog Timer, Oscillator Start-up Timer, Power-up Timer Requirements .....	417
SPI1 Master Mode (Full-Duplex, CKE = 0, CKP = x, SMP = 1) Requirements .....	441
SPI1 Master Mode (Full-Duplex, CKE = 1, CKP = x, SMP = 1) Requirements .....	440
SPI1 Master Mode (Half-Duplex, Transmit Only) Requirements .....	439
SPI1 Maximum Data/Clock Rate Summary .....	438
SPI1 Slave Mode (Full-Duplex, CKE = 0, CKP = 0, SMP = 0) Requirements .....	449
SPI1 Slave Mode (Full-Duplex, CKE = 0, CKP = 1, SMP = 0) Requirements .....	447
SPI1 Slave Mode (Full-Duplex, CKE = 1, CKP = 0, SMP = 0) Requirements .....	443
SPI1 Slave Mode (Full-Duplex, CKE = 1, CKP = 1, SMP = 0) Requirements .....	445
SPI2 Master Mode (Full-Duplex, CKE = 0, CKP = x, SMP = 1) Requirements .....	429
SPI2 Master Mode (Full-Duplex, CKE = 1, CKP = x, SMP = 1) Requirements .....	428
SPI2 Master Mode (Half-Duplex, Transmit Only) Requirements .....	427
SPI2 Maximum Data/Clock Rate Summary .....	426
SPI2 Slave Mode (Full-Duplex, CKE = 0, CKP = 0, SMP = 0) Requirements .....	437
SPI2 Slave Mode (Full-Duplex, CKE = 0, CKP = 1, SMP = 0) Requirements .....	435
SPI2 Slave Mode (Full-Duplex, CKE = 1, CKP = 0, SMP = 0) Requirements .....	431
SPI2 Slave Mode (Full-Duplex, CKE = 1, CKP = 1, SMP = 0) Requirements .....	433

Timer1 External Clock Requirements .....	418
Timer2/Timer4 External Clock Requirements .....	419
Timer3/Timer5 External Clock Requirements .....	419
UARTx I/O Requirements .....	454
ADC .....	
Control Registers .....	325
Helpful Tips .....	324
Key Features .....	321
Resources .....	324
Arithmetic Logic Unit (ALU) .....	44
Assembler .....	
MPASM Assembler .....	398
B .....	
Bit-Reversed Addressing .....	115
Example .....	116
Implementation .....	115
Sequence Table (16-Entry) .....	116
Block Diagrams .....	
Data Access from Program Space .....	
Address Generation .....	117
16-Bit Timer1 Module .....	203
ADC Conversion Clock Period .....	323
ADC with Connection Options for ANx Pins and Op Amps .....	322
Arbiter Architecture .....	110
BEMF Voltage Measurement Using ADC .....	34
Boost Converter Implementation .....	32
CALL Stack Frame .....	111
Comparator (Module 4) .....	356
Connections for On-Chip Voltage Regulator .....	384
CPU Core .....	36
CRC Module .....	373
CRC Shift Engine .....	374
CTMU Module .....	316
Digital Filter Interconnect .....	357
DMA Controller .....	141
DMA Controller Module .....	139
dsPIC33EPXXXGP50X, dsPIC33EPXXXMC20X/50X and PIC24EPXXXGP/MC20X .....	25
ECAN Module .....	288
EDS Read Address Generation .....	105
EDS Write Address Generation .....	106
Example of MCLR Pin Connections .....	30
High-Speed PWMx Architectural Overview .....	227
High-Speed PWMx Register Interconnection .....	228
I2Cx Module .....	274
Input Capture x .....	213
Interleaved PFC .....	34
Multiphase Synchronous Buck Converter .....	33
Multiplexing Remappable Output for RPN .....	180
Op Amp Configuration A .....	358
Op Amp Configuration B .....	359
Op Amp/Comparator Voltage Reference Module .....	356
Op Amp/Comparator x (Modules 1, 2, 3) .....	355
Oscillator System .....	153
Output Compare x Module .....	219
PLL .....	154
Programmer's Model .....	38
PTG Module .....	338
Quadrature Encoder Interface .....	250
Recommended Minimum Connection .....	30